

## Compact, powerful, innovative!

With the highest in-class resolution of 4 nm, the FlexSEM 1000 II offers user-friendly operation and sophisticated automatic functions for a wide range of users, from beginners to experts.



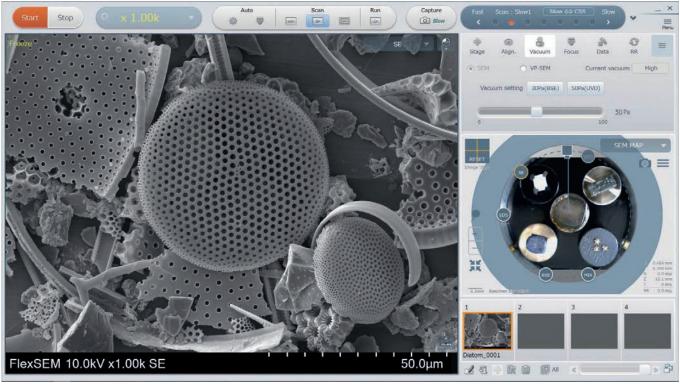
Easy, Quick, and Compact	User support function provides prompt observation	<b>≻</b> P3
High image quality	Advanced performance in a compact body	<b>▶</b> P5
3D measurement	3D measurement by Hitachi map 3D*	<b>≻</b> P8
Smooth operation	Improved observation throughput by easy operation	<b>▶</b> P9
Easy to search a field of view	Searching a field of view intuitively by using the camera navigation system*	<b>▶</b> ₽11

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Specimen: diatom

 $* \, \text{The image on the screen includes options.} \\$ 





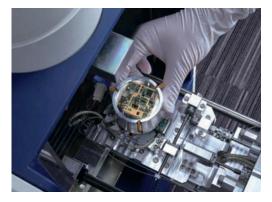




## Multiple integrated features for intuitive operation.

## Specimen holder





## Automated image corrections for easy operation

Before adjustment



## User interface with improved software



▶ P9

## Compact design

A space and energy saving system with performance comparable to larger scanning electron microscopes

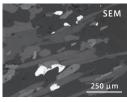


52% more space saving (compared to SU1510) 45% lighter (compared to SU1510) Power source: 1 kVA (connect to outlet)

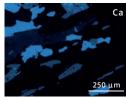


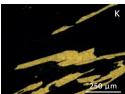
## **Upgradeable Options for varic**

## **EDS** analysis



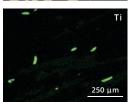








Magnification: 150x



Specimen: mineral

Specimen courtesy of Dr. Mamoru Adachi, the Nagoya University Museum

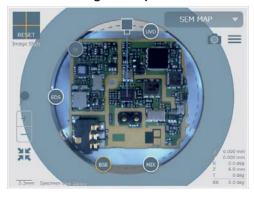




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## Extensive user operation support functions

■Easy operation with use of camera navigation system\*

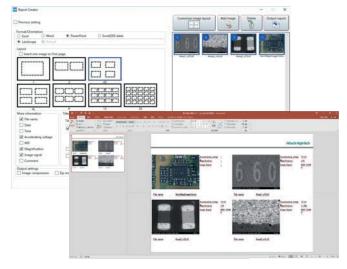






Specimen: electronic circuit board

■Generating reports easily with "Report Creator"

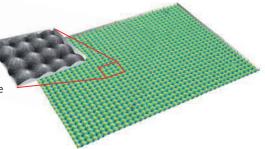


Simply select images and template to generate customize reports.

## Three-Dimensional measurement by Hitachi map 3D

Hitachi map 3D is a measurement and three-dimensional model display

software package designed for the use with Hitachi SEM images. Three-dimensional images can be generated without tilting the sample or worrying about image shift since the Hitachi map 3D utilizes the directional signal from Hitachi's segmented quad BSE detector.

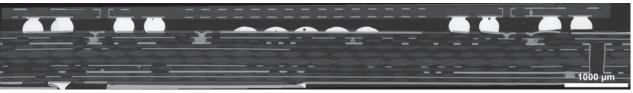


Parameters	Unit		
Projected area	%	51.0	41.8
Volume of void	%	11.7	73.6
Volume of material	%	88.3	26.4
Volume of void	nm³/µm²	10814105	27741380
Volume of material	$nm^3/\mu m^2$	81350583	9972952
Mean thickness of void	nm	10.8	27.7
Mean thickness of material	nm	81.4	9.97

Specimen: microlens

## Wide area observation by image tiling (Zigzag Capture)

Zigzag Capture automatically moves the stage at pre-determined intervals to enable Multi-field acquisition.



Specimen: electronic component (prepared with ion milling)

\* Option





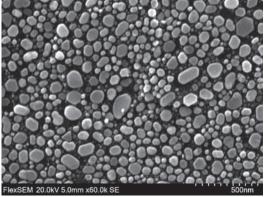




## Compact and high-performance electron optics

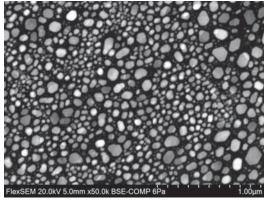
Equipped with a low-aberration objective lens, providing high resolution in a compact body.

#### SE image resolution: 4.0 nm



Accelerating voltage: 20.0 kV, Magnification: 60,000x

#### BSE image resolution: 5.0 nm



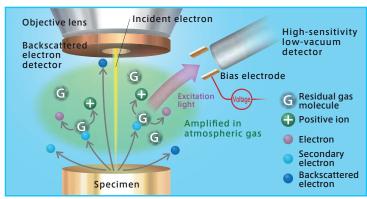
Accelerating voltage: 20.0 kV, Magnification: 50,000x, Vacuum: 6 Pa

Specimen: evaporated Au particles



## Non-conductive specimen observation

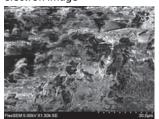
Observation of non-conductive specimens is available by using the VP mode with charge artifact reduction. High-contrast images are obtained due to improved sensitivity of the backscattered electron. Hitachi's ultra variable-pressure detector (UVD\*) generates a secondaryelectron-type image by detecting visible light excited by the electron-gas interaction.



Detection principle of high-sensitivity low-vacuum detector (UVD)

Charge artifacts can occur in high vacuum causing image distortion, such as image drift, extreme contrast changes, and other false information. However, by controlling the electrostatic charge on the specimen using VP mode, a clear observation of the specimen's surface structure is possible.

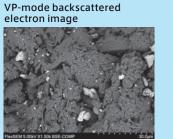
#### High-vacuum secondary electron image





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Specimen: polyvinyl alcohol

\* Optional







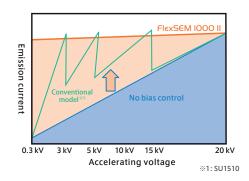


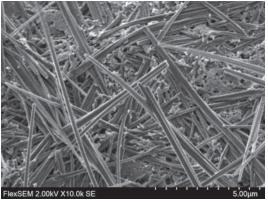


## High-contrast observation with the Beam Brightness system

"Beam Brightness" is a system to maintain high-emission current regardless of accelerating voltage.

With this system, high-contrast images can be obtained continuously, even at low accelerating voltage levels.





Accelerating voltage: 2.0 kV, Magnification: 10,000x Signal: secondary electron image

Specimen: tablet candy



Accelerating voltage: 3.0 kV, Magnification: 500x Signal: UVD

Specimen: superabsorbent polymer



## New generation ultra variable-pressure detector (UVD-II)\*1

The UVD-II, a ultra variable-pressure detector with improved signal detection capability, provides a signal-to-noise ratio approximately 1.5 times higher than the previous-generation UVD.



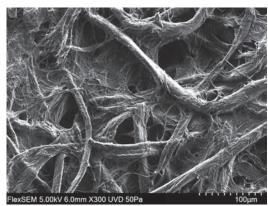
Accelerating voltage: 5.0 kV, Magnification: 150x Signal: UVD-II

Specimen: resin fracture

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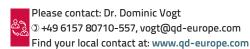


Accelerating voltage: 5.0 kV, Magnification: 300x Signal: UVD-II

Specimen: paper filter

\*1 Optional



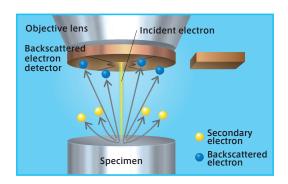


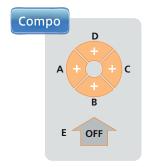


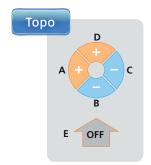


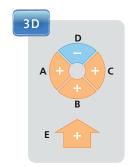
## High-sensitivity semiconductor backscattered electron detector

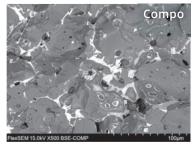
The semiconductor backscatter detector consists of five elements, enabling simultaneous signal collection from each segment. By changing their configuration, the detector takes images which emphasize composition information, shadow images which emphasize topographic information, and 3D images which emphasize both compositional and topographic information.

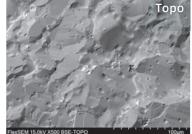


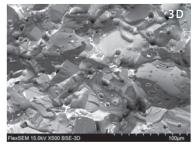




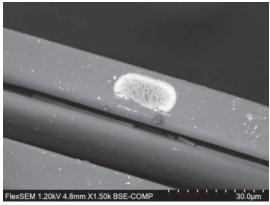




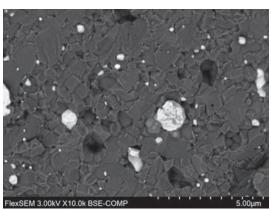




Accelerating voltage: 15.0 kV, Magnification: 500x, Specimen: varistor



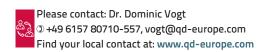




Accelerating voltage: 3.0 kV, Magnification: 10,000x

Specimen: Al-Ni composite material

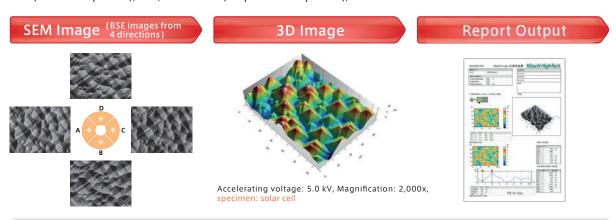




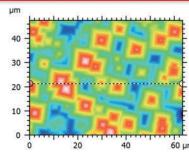


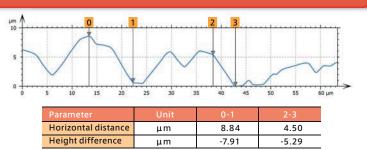
## 3D surface reconstruction and height measurement of the specimen

Hitachi map 3D captures all four directional images simultaneously with a high-speed, segmented Backscattered Electron Detector (BSED), supports various measurements such as height, area, and volume as well as ISO-compliant surface roughness. Moreover, report data can be output to several formats including RTF (Word-compatible), PDF, STL format (3D printer compatible), and more.



## Height and angle measurement of extracted cross-section





#### Main specifications

#### 3D Image Capture(Three-Dimensional data capture func+on)

or mage capture ( more removement and capture rand con,		
Item	Description	
Capture func+on	Automatic image data acquisition by Hitachi's segmented quad BSE detector	
Capture pixel count	640x480, 1,280x960	
Data capture +me (Scan speed)	10~320s	

#### PC installation requirements

Item	Description
Windows versions	Windows® 7, 8, .x 10(x64 or x32)
Processor	Quadcore processor
RAM memory	8 GB or more
Graphic board	Open GL 2.0 or Direct 3D 9.0c
HDD free space	800 MB or more
Other	1 free USB port

Note:
"Windows" is a registered trademark of Microsoo Corpora+on in the United States and other countries.

#### Hitachi map 3D

	Description
Import function	Automatic select and read function of four segment BSE image data
	Measurement performance varies depending on calibration accuracy, the condition of the type of specimen, the observation mode, and the observation condition. Detectable angle range $\pm 60^\circ$ (reference)
Measurement function	Measurement based on the ISO, JIS, ASME, EUR, and GB standards
	Section profile display extracted between any area on the three dimensional image
	Distance of X and Y, length and any angle measurements between two points, surface area, and volume
	Distance of X, Y, and Z, length and many other measurement functions between 2 points specified on section profile
	Simple profile and surface roughness measurements
	Baseline (straight, curve), leveling, and multiple offsets
	Cutting surface, Color contour line, Bird' s-eye view, and pseudo color display
	Layout, templates, and image composition from multiple-image function
Three-dimensional display function	Rotation, zoom-in, and multiple rendering processes. Animation video record function of observation screen
Output function	Report/image: PDF, RTF/PNG, JPG, GIF, TIF, BMP, EMF
	3D image/movie: SUR, 3MF, STL, WRL, TXT/X3D/WMV, AVI







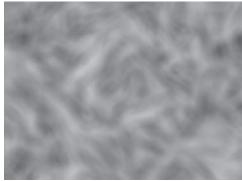




## Automatic image corrections which do not require an expert

Improved high-speed automatic image correction algorithms shorten latency time by approximately 70% compared with conventional models\*1, realizing high-throughput data acquisition minimizing or eliminating various image adjustments.

### Before adjustment



### After adjustment



Specimen: tuff volcanic ash Specimen courtesy of professor emeritus Masahiro Kitada, Tokyo University of the Arts



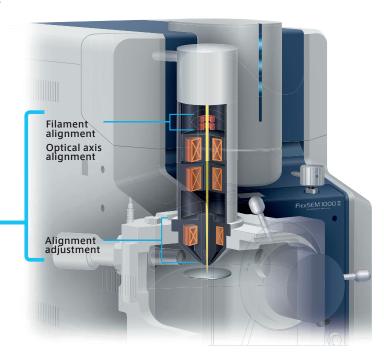
\*1:SU1510



## Auto axis alignment

Multiple alignments, including optical axis and gun alignments after filament replacement, are automatically controlled. This prevents misalignment of the optical axis or field of view and helps obtaining high-quality images repeatedly without relying solely on the user's skills.

Auto beam adjustment







## User interface with improved software

New graphical user interface supports touchscreen capability for all operations, including stage control and observation conditions. The size of the main window has been increased to 1,280 x 960 pixels, with the subwindow displaying our new navigation system, SEM MAP. SEM MAP visually displays stage location and confirms the current observation point with respect to the entire sample. Additionally, the subwindow can be switched from SEM MAP to display different signals, to be displayed and captured simultaneously.



Specimen: tuff volcanic ash



## Mouse-driven smart functions

### **RISM\***

Function to center the region of interest by clicking any point on the live image.



Click to move to the center of the screen









Function to move the field of view by clicking and dragging any point on the live image.

\*Rapid Image Shift Mode



Dragging freely

## ZOOM

Click and drag over any point on the live image moves the field of view with the selected area to the center and increases the magnification automatically.



Circle the point to enlarge at the center

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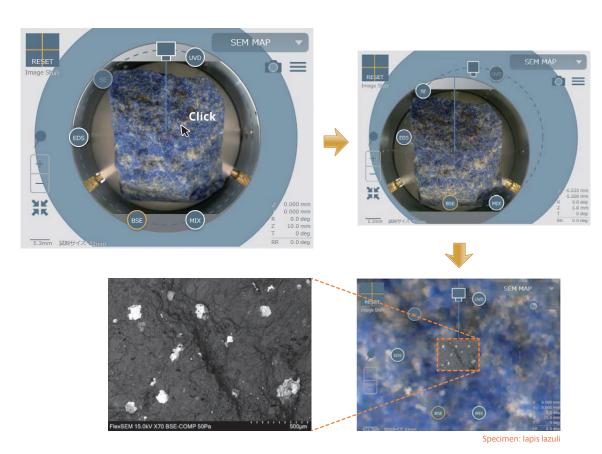
Specimen: electronic circuit board





## Easy to search a field of view with the integrated camera navigation system

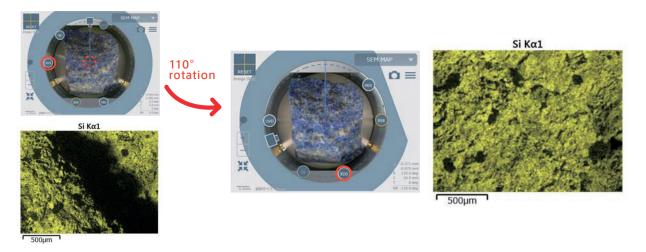
Navigate to any location via SEM MAP and quickly reach your observation area simply by clicking on the optical image. The optical image from the built-in camera (or from an external source) can be zoomed in and out, or switched with a high-resolution SEM image.



SEM MAP interface is designed to easily grasp the relationship between any of the SEM detectors and the specimen. All of the detector locations are indicated on the SEM MAP display, designating their position around the specimen as it is rotated.

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## Wide area observation of multiple areas on optical camera image or SEM image

Multi Zigzag (sequential field-of-view image capturing) is a function that generates a low-magnification image out of multiple high-magnification images taken with different fields of views. This enables wide-area observation with low-magnification/high-resolution images that are

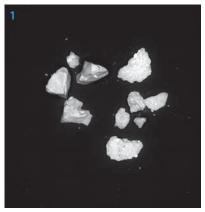
This enables wide-area observation with low-magnification/high-resolution images that are difficult to capture manually by using a SEM. In addition to the conventional Zigzag functions, multiple areas over multiple specimens can be defined in Multi Zigzag.

### Area definition

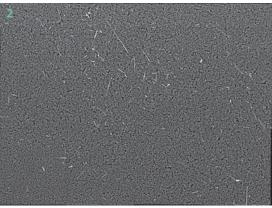


### Observation conditions setting





Signal: backscattered electron Specimen: mineral Number of images taken: 35 (7 vertically x 5 horizontally)



Signal: backscattered electron Number of images taken: 60 (10 vertically x 6 horizontally)

Specimen: asbestos



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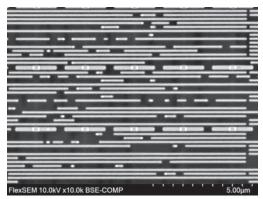
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Signal: backscattered electron Number of images taken: 54 (18 vertically x 3 horizontally) Milling unit: ArBlade®5000

Specimen: electronic component

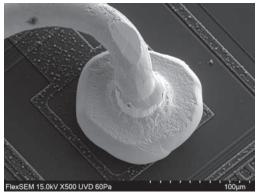


## **Electronic components**



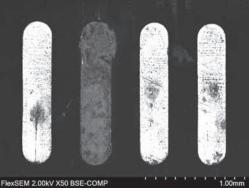
Accelerating voltage: 10.0 kV, Magnification: 10,000x

Specimen: semiconductor device



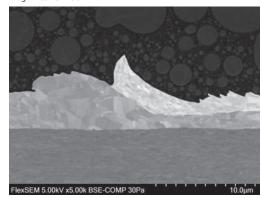
Accelerating voltage: 15.0 kV, Magnification: 500x(UVD used)

Specimen: wire bonding



Accelerating voltage: 2.0 kV, Magnification: 50x

Specimen: metal terminal



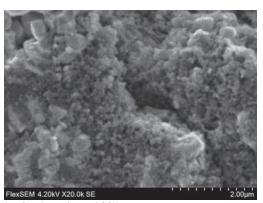
Accelerating voltage: 5.0 kV, Magnification: 5,000x (Ion milling used)

Specimen: Au bonding

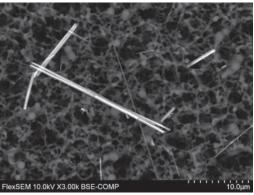
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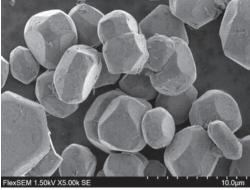
## **Environmental & energy material**



Accelerating voltage: 4.2 kV, Magnification: 20,000x

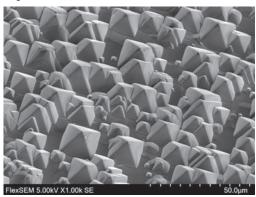


Accelerating voltage: 10.0 kV, Magnification: 3,000x



Accelerating voltage: 1.5 kV, Magnification: 5,000x

Specimen: phosphor



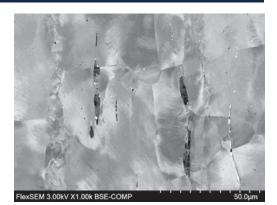
Accelerating voltage: 5.0 kV, Magnification: 1,000x

Specimen: solar cell

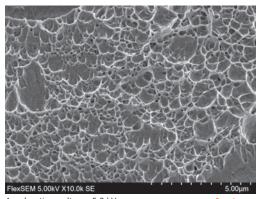




## Metallurgy

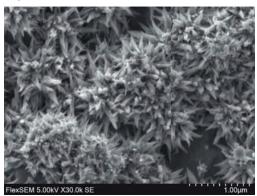


Accelerating voltage: 5.0 kV, Magnification: 1,000x (Ion milling used)



Accelerating voltage: 5.0 kV, Magnification: 10,000x

fracture surface of metal

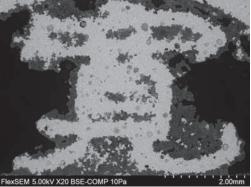


Accelerating voltage: 5.0 kV, Magnification: 30,000x

hydrogen storage alloy

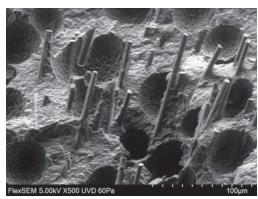
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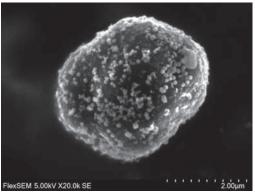


Accelerating voltage: 5.0 kV, Magnification: 20x(Ion milling used) Sample courtesv of professor emeritus Masahiro Kitada. Tokvo University of the Arts

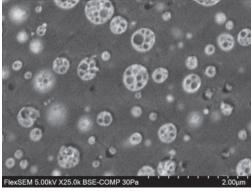
## Polymer materials



Accelerating voltage: 5.0 kV, Magnification: 500x(UVD used) Specimen: resin with glass fiber ©Akita Industrial Technology Center

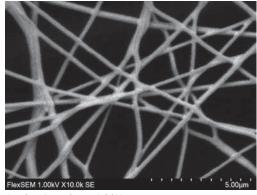


Accelerating voltage: 5.0 kV, Magnification: 20,000x



Accelerating voltage: 5.0 kV, Magnification: 25,000x

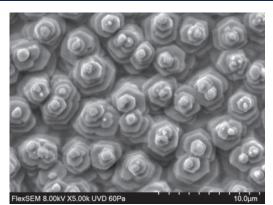
Specimen: ABS resin



Accelerating voltage: 1.0 kV, Magnification: 10,000x Sample courtesy of Nafias corporation



## Life Science



Accelerating voltage: 8.0 kV, Magnification: 5,000x

Specimen: abalone's shell

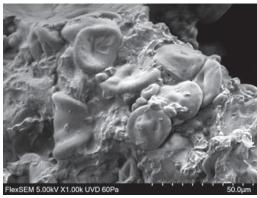


Accelerating voltage: 3.0 kV, agnification: 150x

Sample courtesy of associate professor

Daisuke Koga, Department of

Microscopic Anatomy and Cell Biology, Asahikawa Medical College



Accelerating voltage: 5.0 kV, Magnification: 1,000x



Magnification: 500x



## Smooth and quick analysis by using camera navigation system\*

FlexSEM incorporates observation to analysis smoothly by using the camera navigation system in conjunction with EDS. Correlative results from the acquisition of high-resolution SEM images and mapping images from an ultra-wide area can be displayed.

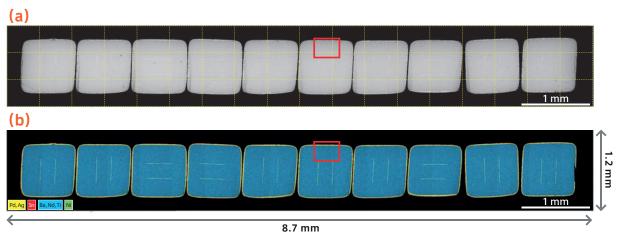
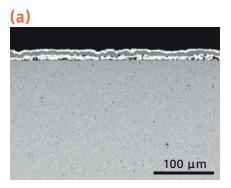
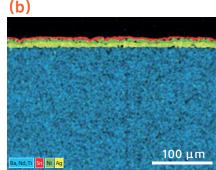


Figure 1: Result of wide area observation and analysis of cross-section of the ceramic capacitor (a) SEM image (b) EDS layer image





Specimen: 10 ceramic capacitors EDS: AZtec Energy\* Accelerating voltage: 15.0 kV Signal: backscattered electron image Magnification: 250x Number of images taken: 54 (18 horizontally x 3 vertically)

Figure 2: Enlarged image (a) SEM image (b) EDS layer image

### Main energy dispersive X-ray analyzer

Product name	AZtecOne/AZtecEnergy	Quantax80	Element
Type of detector	Silicon drift detector	Silicon drift detector	Silicon nitride SDD detector
Detection area	30 mm <sup>2</sup>	30 mm <sup>2</sup>	30 mm <sup>2</sup>
Energy resolution	158 eV(Cu-Ka)	148 eV(Cu-Ka)	129 eV(Mn-Ka)
Detectable element	B <sup>5</sup> ~U <sup>92</sup>	B <sup>5</sup> ~Cf <sup>98</sup>	Be <sup>4</sup> ~Am <sup>95</sup>
Manufacturer	Oxford Instruments plc.	Bruker Nano GmbH	AMETEK Inc.

\* Optional









## Easy maintenance

Pre-centered filament cartridges which require no adjustment are included as standard. A step-by-step guide and automated axis-alignment function make for easy filament replacement.

## Filament replacement

### **step 1** Press AIR button and wait until the chamber reaches atmosphere.

After the specimen chamber reaches atmosphere, wait 30 minutes in order to let the filament cool completely before removing it.

## **step 2** Open the electron gun and remove the filament.



## **step 3** Replace the filament with a new one.



- ·Spacer that comes with cartridge filament must be installed.
- ·Clean if necessary.

## **step 4** Attach the filament and close the electron gun.



·Make sure that no dust enters the electron gun or inside the column.

## **step 5** Set the calibration specimen.

**step 6** Select a button for auto alignment or manual alignment.



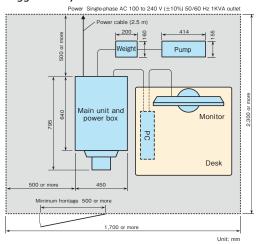
## Compact and flexible layout

Compact design that can be installed in small space. The main unit can be placed either on a power box or tabletop, and observation can be done as a part of routine work, without sitting down in a chair.

### ■Main unit & power box combined



#### Suggested layout



### ■Main unit & power box separated



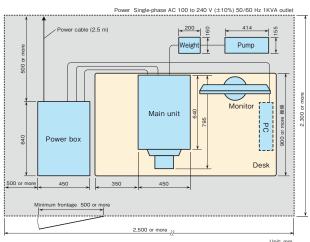
Scereen shows simulated image.

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#### Suggested layout



Note 1: Minimum load weight of the desk must be 200 kg. Note 2: Relocation of the main unit to the desk should be handled by service engineers.



### FlexSEM 1000 ■ Specifications

### ■ Specifications FlexSEM 1000 II SU1000 4.0 nm (Accelerating voltage 20 kV, WD = 5 mm, high-vacuum mode) 15.0 nm (Accelerating voltage 1 kV, WD = 5 mm, high-vacuum mode) Backscattered electron 5.0 nm (Accelerating voltage 20 kV, WD = 5 mm, VP mode) 6x to 300,000x (magnification ratio of image\*2) 16x to 800,000x (magnification ratio of display\*3) 0.3 kV to 20 kV 6 to 100 Pa (13 steps)

		nable pressure range	0 to 100 Fa (13 steps)
Image shift		age shift	$\pm$ 50 $\mu$ m(WD=10 mm)
	Maximum specimen size		80 mm in diameter
		X	0 to 50 mm
		Υ	0 to 40 mm
		Z	5 to 33 mm
		R	360°
		Т	-15° to +90°
	Specimen	Maximum observable range	64 mm in diameter (combined with Rotation)
		Motor drive	3-axis (X, Y, R)

	EDS analysis WD	WD=10 mm(T.O.A=30°)
ш		Auto beam adjustment (AFS → ABA → AFC → ABCC), Auto optical axis alignment (current alignment), Auto beam brightness control
	Automatic image controller	Auto brightness & contrast control (ABCC), Auto focus control (AFC), Auto astigmatism correction & focus (ASE)

Auto filament saturation (AFS), Auto beam alignment (ABA). Auto start (HV-ON → ABCC → AFC) 640 × 480 pixels, 1,280 × 960 pixels. 2,560  $\times$  1,920 pixels, 5,120  $\times$  3,840 pixels  $\mathsf{BMP},\mathsf{TIFF},\mathsf{JPEG}$ Image number, Accelerating voltage, magnification, micron marker,

Precentered cartridge type tungsten hairpin filament Secondary electron detector, high-sensitivity

micron value, WD value, date, time, vacuum level, detector Main display: 1,280  $\times$  960, sub display: 640  $\times$  480 separate window of sub display: 1,280  $\times$  960 Fully automatic valve system

1 pump, 61 L/s 1 pump, 100 L/min (50 Hz), 120 L/min (60 Hz) Raster rotation, dynamic focus, image enhancement, data input (measurement between two points, measurement of angle, characters), preset magnification, stage location navigation system (SEM MAP), beam marking, Report creator Protection function for the power failure, electric leakage

and vacuuming operation are equipped.

■Recommended PC specifications

Item	Description
OS	Microsoft® Windows®10 Pro 64bit
CPU	Intel® Xeon® E3-1225 v5 with Intel HD Graphics PS30 or nigher compatible prosseor.
On-board memory	8 GB or more
Display resolution	1,920 × 1,080 pixels
Memory device	HDD, DVD-ROM drive

#### ■Dimension & Weight

Item	Description
Main unit	450 (W) × 795 (D) × 690 (H) mm, 107 kg
Power box	450 (W) × 640 (D) × 450 (H) mm, 58 kg
Rotary pump	155 (W) × 414 (D) × 315 (H) mm, 22 kg
Weight	160 (W) × 200 (D) × 134 (H) mm, 26 kg

#### ■Installation requirements

Item	Description
Temperature	15 to 30 ℃
	70% RH or less
Power	Single-phase AC 100 to 240 V (±10%)

#### Accessories

Itom	Beschiption
Temperature	15 to 30 ℃
Humidity	70% RH or less
	Single-phase AC 100 to 240 V (±10%)
<b>-</b> • • • • • • • • • • • • • • • • • • •	

Detector/various analyzers
Energy dispersive X-ray spectrometer (EDS)
Ultra variable-pressure detector (UVD-II)

#### Camera navigation system

	stage/	

#### Multi sample holder

#### Software

SEM data manager

## Hitachi map 3D

#### Multi Zigzag

## Trackball

#### Joystick

### Control panel

- \*3: Magnification is defined with a display size of 509.8 mm × 286.7 mm (1,920 × 1,080 pixels).
- #5: Rotary pump may not be included with main unit depending on its destination.

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## Science for a better tomorrow

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Notice: For correct operation, follow the instruction manual when using the instrument.

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